

PRM6R0N06E

PFC Device Corporation

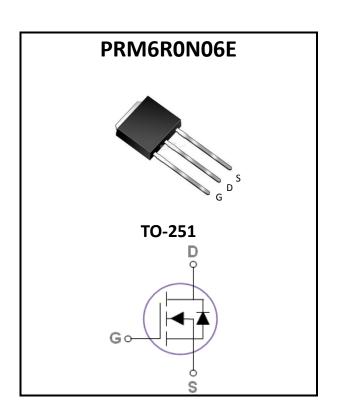
60V Single N-Channel MOSFET

Major ratings and characteristics

Characteristics	Values	Units
V_{DS}	60	٧
$I_{D}^{6} (T_{C}=25^{\circ}C)$	50	Α
Max. R _{DS(ON)} @V _{GS} =10V	6	mΩ
Max. R _{DS(ON)} @V _{GS} =4.5V	8	mΩ
T _J Operating Junction Temperature	-55 to +150	°C

General Description

The N-Channel enhancement mode power field effect transistor is using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. The device is well suited for high efficiency fast switching applications.



Typical Applications

- Charger Adapter
- Power Tools
- LED Lighting

Features

- Max. $R_{DS(ON)}=6m\Omega@V_{GS}=10V$
- Improved dv/dt capability
- Fast switching
- 100% E_{AS} Guaranteed
- Green Device Available

1. Characteristics

Maximum Ratings Characteristics

($T_A = 25$ °C unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D^{5}	Drain Current – Continuous (T _C =25°C)	95.3	Α
ID	Drain Current – Continuous (T _C =100°C)	60.3	Α
I_D^6	Drain Current – Continuous (T _C =25°C)	50	Α
I _{DM}	Drain Current – Pulsed ¹	200	Α
E _{AS}	Single Pulse Avalanche Energy ²	80	mJ
I _{AS}	Single Pulse Avalanche Current ²	40	А
D	Power Dissipation (T _C =25°C)	104	W
P_D	Power Dissipation – Derate above 25°C	0.83	W/°C
T _{STG}	Storage Temperature Range	-55 to 150	°C
T _J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient		62	°C/W
$R_{ heta JC}$	Thermal Resistance Junction to Case		1.2	°C/W



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Electrical Characteristics

(T_J = 25 °C unless otherwise specified)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	60			V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =60V, V _{GS} =0V, T _J =25°C			1	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm20V$, $V_{DS}=0V$			±100	nA

On Characteristics

D	R _{DS(ON)} Static Drain-Source On-Resistance	V _{GS} =10V, I _D =20A			6	mΩ
K _{DS(O}	Static Dialii-Source Off-Resistance	V _{GS} =4.5V, I _D =10A	ł		8	mΩ
$V_{GS(th}$	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=250uA$	1.0		3.0	V
g _{fs}	Forward Transconductance	V _{DS} =5V, I _D =20A		60		S

Dynamic and switching Characteristics

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Q_{g}	Total Gate Charge ^{3, 4}		 85		
Q_{qs}	Gate-Source Charge ^{3, 4}	V_{DS} =30V, V_{GS} =10V, I_{D} =20A	 15		nC
Q_{qd}	Gate-Drain Charge ^{3, 4}		 20		
$T_{d(on)}$	Turn-On Delay Time ^{3,4}		 25		
T _r	Turn-On Rise Time ^{3, 4}	V_{DD} =30V, V_{GS} =10V, R_{G} =6 Ω I_{D} =20A	 110	-	20
$T_{d(off)}$	Turn-Off Delay Time ^{3,4}		 69		ns
T _f	Turn-Off Fall Time ^{3, 4}		 115		
C _{iss}	Input Capacitance		 4950		
C _{oss}	Output Capacitance	V _{DS} =25V, V _{GS} =0V, f=1MHz	 310		рF
C_{rss}	Reverse Transfer Capacitance		 200	-	
R_{q}	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	 0.6		Ω

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	V _{GS} =0V, I _S =20A	 	1.5	V
t _{rr}	Reverse Recovery Time	1 201 di/dt 1001/up	 22		ns
Q _{rr}	Reverse Recovery Charge	I _S =20A, di/dt=100A/us	 10		nC

Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. L=0.1mH, R_G =25 Ω , Starting T_J =25 $^{\circ}C$
- 3. The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.
- 4. Essentially independent of operating temperature.
- 5. Silicon limited.
- 6. Package limited.

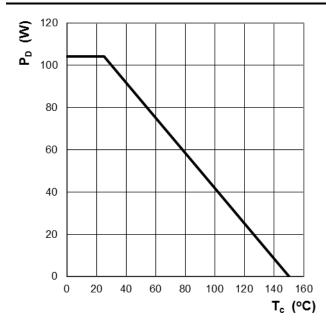


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2. Characteristics Curves

Ratings and Characteristics Curves

(T_A = 25° unless otherwise specified)



120 100 80 60 40 20 25 50 75 100 125 150 T_c (°C)

Figure 1: Power Dissipation

Figure 2: Continuous Drain Current vs. T_C

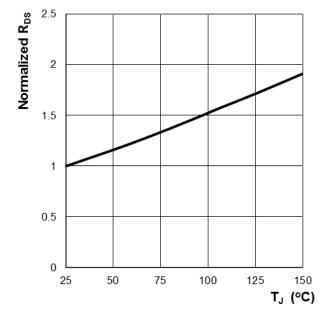


Figure 3: Normalized $R_{DS(ON)}$ vs. T_J

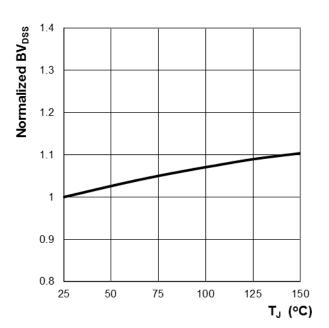


Figure 4: Normalized BV_{DSS} vs. T_J



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Ratings and Characteristics Curves

(T_A = 25° ∪ unless otherwise specified)

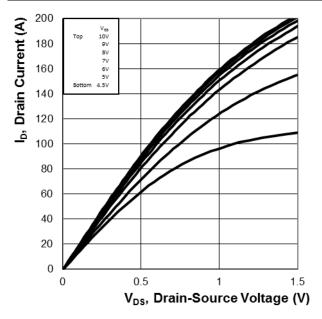


Figure 5: On-Region Characteristics

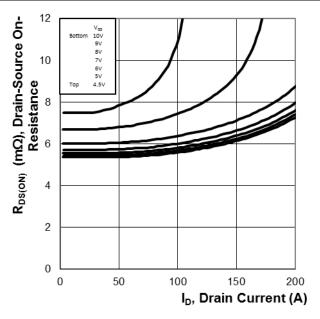


Figure 6: Typ. R_{DS} Variation vs. I_D and V_{GS}

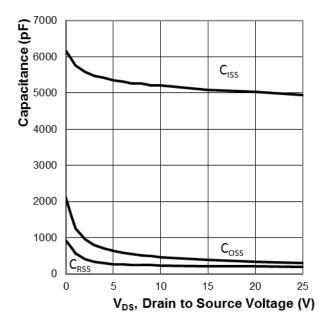


Figure 7: Typ. Capacitance Characteristics

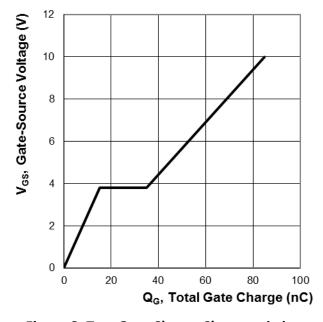


Figure 8: Typ. Gate Charge Characteristics



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Ratings and Characteristics Curves

($T_A = 25^{\circ}C$ unless otherwise specified)

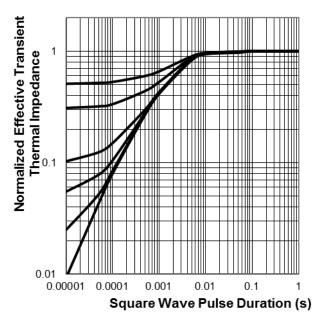


Figure 9: Normalized Thermal Transient Impedance, Junction-to-Case

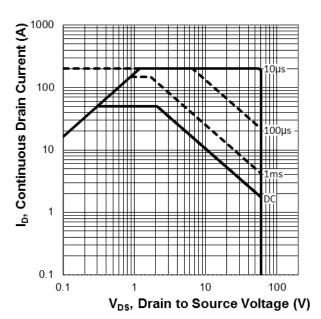


Figure 10: Maximum Safe Operation Area



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3. Marking information

Top Marking Rule

PFC PRM
6R0N06E
YYWW ABSH

PRM6R0N06E = Product Type Marking Code

YYWW = Date Code

YY = Last two digits of year

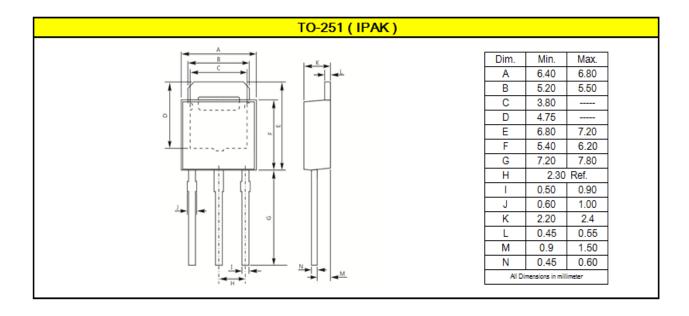
WW = Week code

ABS = Assembly code

H = Halogen Free (N/A = common molding compound)

4. Package information

Package Outline Dimensions millimeters





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5. Ordering information

Part Number	Package	Delivery mode
PRM6R0N06E	TO-251 (I-PAK)	75 pcs / Tube

Mechanical

Molder Plastic: UL Flammability Classification Rating 94V-0
 Device Weight: 0.01 ounces (0.3grams) - TO-251 (I-PAK)

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